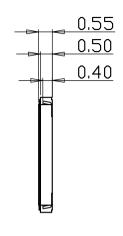
### 0.50 1 3 0.50

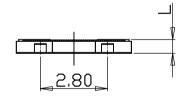


# 3.70

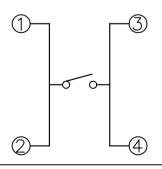
PCB DIMENSION

# <u>SPECIFICATION</u>

- 1. OPERATING FORCE: 160gf±50gf
- 2. GENERAL TOLERANCE: ±0.3
- 3. TRAVEL :0.2±0.1m/m
- 4. CONTACT RESISTANCE :  $100 \text{m}\Omega$  MAX
- 5. LIFE:100,000CYCLES MIN
- 6. REEL PACKING :7,000pcs
- 7. L =0.55mm



# Circuit Diagram



# NOTE

1. Omission Dimensions To CAD Data File Reference.

	4	DUST CO	POL	_YIMIDE-	0.06t	NT	1					
3		CONTA	СТ	SUS301- 0.05t			Ag(CLAD)	1				
2		TERMI	5210R-EH 0.1t			Ag	1					
1		CASE	LCP			BK	1					
No.		DESCR1PT1	:DNS	MATERIAL			FINSH/COLOR	Q'TY	REMARK			
<u>A</u>				RIGON- METRY	UNIT	SCALE	TACT	TACT SWITCH				
A			AF	PPD	CHKD	DSGD						
A												
Δ							MODEL INT	110711057	\			
ND	10. 05 .06	CORRECTION					IIVI	- INT-1197U05A				

INNOCENT ELECTRONICS CO., LTD.

# TACT SWITCH SPECIFICATION

### 1.GENERAL

1-1 Switch action : PUSH - ON type S.P.S.T 1-2 Switch rating : DC 12V, 50 mA Max. 1-3 Operation temperature range : - 20  $^{\circ}$ C  $^{\circ}$  70  $^{\circ}$ C

1-4 Preservative temperature range : - 30  $^{\circ}$ C  $^{\sim}$  80  $^{\circ}$ C

1-5 Appearance and dimensions : See outside drawing page

1-6 Standard conditions: Unless otherwise specified, the test and measurements shall be carried out as

follows:

Ambient temperature : 5  $\sim$  35  $^{\circ}$ C Relative humidity : 45  $\sim$  85  $^{\circ}$ RH

Air pressure : 86  $\sim$  106 kPa ( 860  $\sim$  1060 mbar)

However, if doubt arises on the decision based on the measured values under the above- mentioned conditions, the following conditions shall be employed.

Ambient temperature :  $20 \pm 2^{\circ}$ C Relative humidity :  $65 \pm 5^{\circ}$  RH

Air pressure :  $86 \sim 106 \text{ kPa}$  (  $860 \sim 1060 \text{ mbar}$ )

### 2.PERFORMANCE

### 2-1 Electrical characteristics

	NO	ITE	M			TE	PERFORMANCE					
	2.1.		Contact Applying a static load twice the actuating force to the resistance center of the stem, measurements shall be made with									
		resista	ance									
Ш				a 1K	Hz sma	II-current	contact r	esistance	meter			
	2.1.	2 Insula	tion	Meas	uremer	nts shall b	e made fo	ollowing a	pplication of		100 M $\Omega$ min.	
		resista	ance	DC 10	00V pot	ential acr	oss termi	nals and a	across termina	als		
				and fi	rame fo	r one min	ute.					
	2.1.	3 Dielec	tric	AC 2	50 V(50	Hz or 60	Hz) shall	be applie	d across term	inals	There shall be	no
		withst	anding	and a	cross te	erminals a	and frame	for one n	ninute.		breakdown.	
		voltag	е									
	2.1.	4 Bounc	е	Lightl	y strikir	tered	10 msec max.					
			in normal use ( 3 to 4 operations per sec ) bounce shall be									
				tested	d at "ON	N" and "O	FF".					
						-/	_					
					SW	itch	0					
					L E DC	5V	<b>5</b> kΩ •	\$	Oscillo			
							<b>*</b>	ĺ	scope			
						APPROVAL	CHECK	DESIGN	TITLE		INIT 44071	IOED
									TITLE		INT-1197U	ากอล
								강재수	DRAWG		TC C 006	1
N	IARK	DATE	APPR.	CHECK	DESIGN			10.3.25	NO.		TS - S - 096	4

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NO	ITEM	TEST CONDITIONS	PERFORMANCE		
2.2.1	Operation force	Push by recommended operating condition  Force Push force Return force  Stroke	Push force : 250 ± 50gf  Return force : 50 gf min.		
2.2.2	Travel	Push by recommended operating condition  F = ( Operation force ) ×2  Travel	0.2 ± 0.1 mm		
2.2.3	Stop strength	A static load of 3 kgf shall be applied in the direction of stem operation for a period of 60 seconds.	No damage (Electrical and mechanical)		
2.2.5	Vibration test	1)Amplitude: 1.5 mm 2)Sweep rate: 10-55-10 Hz for 1 minute. 3)Sweep method: Logarithmic frequency sweep rate. 4)Vibration direction: X.Y.Z (3 directions) 5)Time: Each direction 2 hours (Total 6 hours)	No 2.1 and 2.2.1 to 2.2.2 shall be satisfied.		
2.2.6	Impact shock test	1)Acceleration: 80 G 2)Cycles of test: 3 cycles each in 6 directions, for a total 18 cycles.	No 2.1 and 2.2.1 to 2.2.2 shall be satisfied.		
2.2.7	Soldering heat test	Soldering area : t/2 of P.W.B thickness $ (P.W.B:t=1.6\;) $ Soldering temperature : 260 $\pm$ 5 $^{\circ}$ C Soldering time : 5 $\pm$ 1 sec.	No damage (Electrical and mechanical)		
		APPROVAL CHECK DESIGN TITLE	INT-1197U05B		
MARK	DATE APPR.	강재수 DRAWG CHECK DESIGN 10.3.25 NO.	ITS - S - 096 2 4		

NO	ITEM	TEST CONDITIONS	PERFORMANCE		
2.3.1	Cold test	1) Temperature : -30 ± 2 °C	Contact resistance		
		2) Duration of test : 96 hours	: 200 mΩ max.		
		3) Take off a drop water	No 2.1.2 to 2.1.4 and 2.2.1		
		4) Standard condition after test: 1 hour	to 2.2.2 shall be satisfied.		
2.3.2	Heat test	1) Temperature : 80 ± 2℃	Contact resistance		
		2) Duration of test : 96 hours	: 200 mΩ max.		
		3) Standard conditions after test : 1 hour	No 2.1.2 to 2.1.4 and 2.2.1		
			to 2.2.2 shall be satisfied.		
2.3.3	Temperature	1) Test cycles : 5 cycles	Contact resistance		
	cycle	2) Standard conditions after test : 1 hour	: <b>200</b> mΩ max.		
		3) 1 cycle :	No 2.1.2 to 2.1.4 and		
		60°C	2.2.1 to 2.2.2 shall be		
		-10°C	satisfied.		
2.3.4	Humidity	1) Temperature : 60 ± 2 ℃	Contact resistance		
	test	2) Relative humidity : 90 $\sim$ 95%	: 200 mΩ max.		
		3) Duration of test : 96 hours	No 2.1.2 to 2.1.4 and		
		4) Take off a drop water	2.2.1 to 2.2.2 shall be		
		5) Standard conditions after test : 1 hour	satisfied.		
2.3.5	Operating	1) DC 5 V, 5 mA Resistance load	Contact resistance		
	life test	2) Operation speed : 2 $\sim$ 3 cycles/sec	: 200 mΩ max.		
		3) Push force : Maximum value of operation force	Bounce : 20 msec max.		
		4) Cycles of operation :100,000 cycles	Actuating force: +10 / -30%		
			initial force		
		No 2.1.2 to 2.1.3 and			
		2.2.2 shall be satisfied.			
		ADDDOVAL CHECK DECICAL	1		
		APPROVAL CHECK DESIGN TITLE	INT-1197U05B		
		강재수 DRAWG	ITS - S - 096 3		
MARK	DATE APPR.	CHECK DESIGN 10.3.25 NO.	113 - 3 - 090 4		

# **INNOCENT ELECTRONICS.CO**

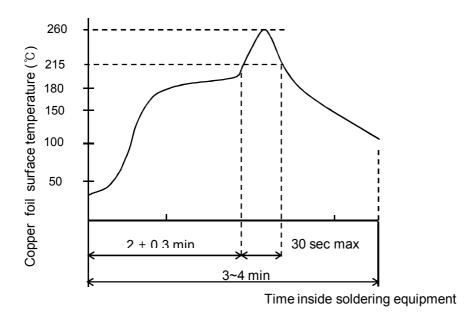
# 3. SOLDERING

# 3-1. Reflow soldering conditions

Preheat : Temperature on the copper foil surface should reach 180  $^{\circ}$ C, 2  $\pm$  0.3minutes after the

P.W.B entered into the soldering equipment.

Soldering heat : Temperature on the copper foil surface should reach the peak temperature of  $260\,^\circ\text{C}$  within 5seconds after the P.W.B entered into soldering heat zone.



**Temperature Profile** 

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								IIILL		
							강재수	DRAWG	ITS - S - 096	4
MARK	DATE	APPR.	CHECK	DESIGN			10.3.25	NO.	113 - 3 - 090	4

# **REEL PACKAGING SPECIFICATION**

# 1. SCOPE

This specification covers the requirements of the taping packinging for INT-1197U05 standard type of tact switches.

# 2. PACKAGING MATERIALS

ITEM	DESCRIPTION				
Package	Cartons				
Deel	Cover: Polystyrene				
Reel	Sideboard : Polystyrene				
Carrier tape	Polystyrene				
Cover tape	Polystyrene				

# 3. PACKANGING QUANTITY

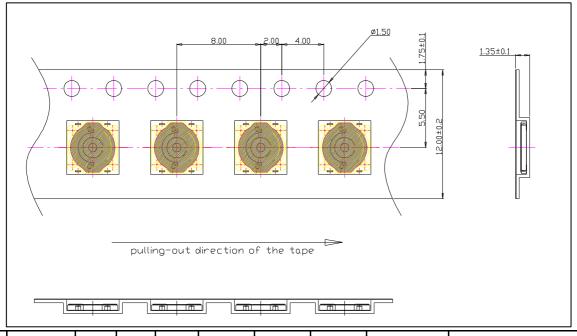
3.1 The number of the reels.

10 reels at maximum. Which contain 70,000 switches shall be packed in a package.

3.2 The number of the switches.

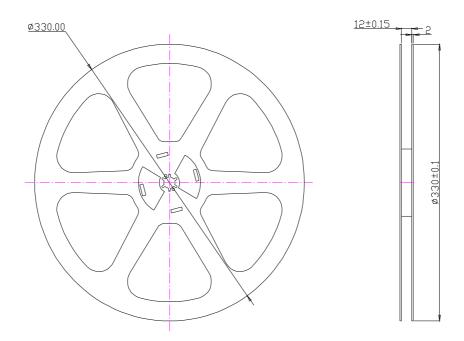
7,000 switches shall be packed in a reel.

# 4. TAPE FORM AND DIMENSIONS



					APPROVAL	CHECK	DESIGN	TITLE	INT-1197	105	
								11166	1141-1197003		
							KJS	DRAWG	ITS - T - 95	1 /	
MARK	DATE	APPR.	CHECK	DESIGN			10.3.25	NO.	113 - 1 - 95	2	

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# 6. PACKAGING PROCEDURE

- 6.1 At the beginning of reeling, the end of the tape, 200mm or more, shall be empty and fit into the groove in the reel core.
- 6.2 After reeling, the end of the tape, 130  $\pm$  4mm, shall be empty and the tape edge shall cut in 45° the cover tape shall be extended 250  $\pm$  10mm from the tape edge and fixed with tape .
- 6.3 Total number of missing switches shall be less then 10 in one reel.( Three consecutive switches may be missing )

# 7. STORAGE CONDITION

Storage environment :  $-20\,^\circ\text{C}$  ~  $50\,^\circ\text{C}$ , 20% ~ 85%RH. (Storage in high temperature and high humidity shall be avoided)

					APPROVAL	CHECK	DESIGN	TITLE	INT-1197U05	
								IIILE		
							KJS	DRAWG	ITS - T - 095	2
MARK	DATE	APPR.	CHECK	DESIGN			10.3.25	NO.	113 - 1 - 095	2